

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
Rth (j-a)	Junction to ambient	SOT82 / SOT194	100	°C/W
		TO220AB	60	
		ISOWATT 220AB	50	
Rth (j-c) DC	Junction to case for DC	SOT82 / SOT194 TO220AB	3.5	°C/W
		ISOWATT 220AB	5.3	
Rth (j-c) AC	Junction to case for 360° conduction angle (F = 50 Hz)	SOT82 / SOT194 TO220AB	2.6	°C/W
		ISOWATT 220AB	4	

GATE CHARACTERISTICS (maximum values)

$P_{G(AV)} = 1 \text{ W}$ $P_{GM} = 10 \text{ W}$ (tp = 20 μs) $I_{GM} = 4 \text{ A}$ (tp = 20 μs) $V_{GM} = 16 \text{ V}$ (tp = 20 μs).

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions		Quadrant		Suffix		Unit	
					T410	T435		
I _{GT}	V _D =12V (DC) R _L =33Ω	T _j =25°C	I-II-III	MAX	10	35	mA	
V _{GT}	V _D =12V (DC) R _L =33Ω	T _j =25°C	I-II-III	MAX	1.5		V	
V _{GD}	V _D =V _{DRM} R _L =3.3kΩ	T _j =125°C	I-II-III	MIN	0.2		V	
tgt	V _D =V _{DRM} I _G = 500mA dI _G /dt = 3A/μs I _{TM} = 5.5A	T _j =25°C	I-II-III	TYP	2		μs	
I _L	I _G =1.2 I _{GT}	T _j =25°C	I-II-III	MAX	30	60	mA	
I _H *	I _T = 100mA gate open	T _j =25°C		MAX	15	35	mA	
V _{TM} *	I _{TM} = 5.5A tp= 380μs	T _j =25°C		MAX	1.75		V	
I _{DRM} I _{RRM}	V _{DRM} Rated V _{RRM} Rated	T _j =25°C		MAX	0.01		mA	
		T _j =125°C		MAX	2			
dV/dt *	Linear slope up to V _D =67%V _{DRM} gate open	V _{DRM} = 400V / 600V	T _j =125°C	MIN	50	250	V/μs	
					30	250		
(dI/dt) _c *	dV/dt = 0.1V/μs		T _j =125°C		MIN	2.7	4.4	A/ms
	dV/dt = 20V/μs				MIN	1.8	2.7	

* For either polarity of electrode A2 voltage with reference to electrode A1.

ORDERING INFORMATION

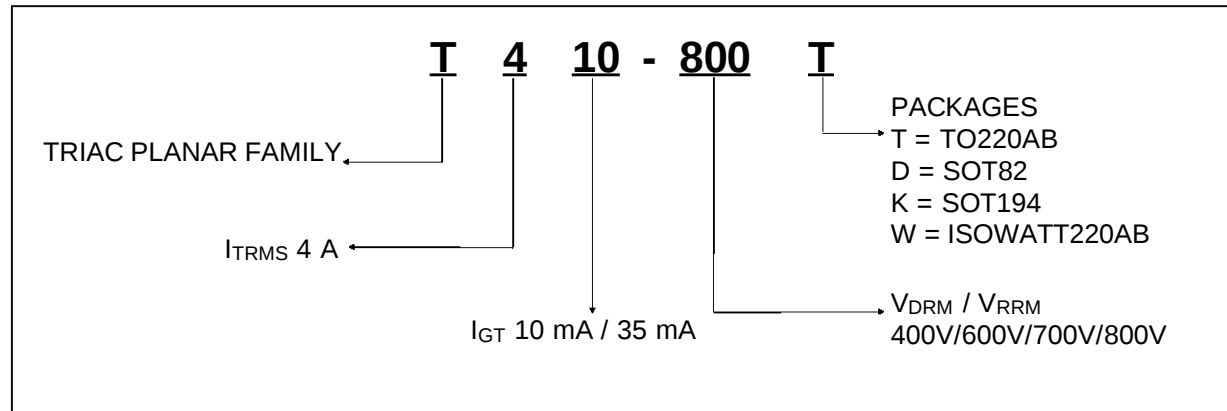


Fig.1 : Maximum RMS power dissipation versus RMS on-state current ($F=50Hz$).
 (Curves are cut off by $(di/dt)_c$ limitation)

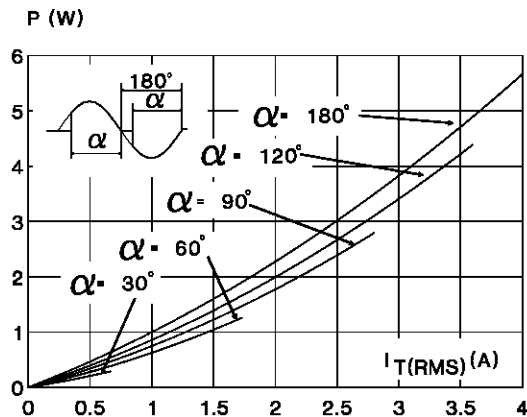


Fig.3 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact (ISOWATT220AB).

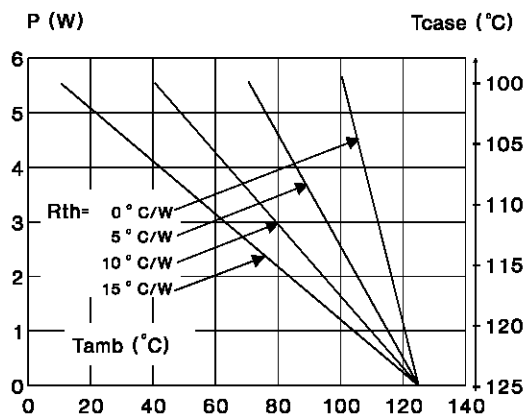


Fig.2 : Correlation between maximum RMS power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact (TO220AB / SOT82 / SOT 94).

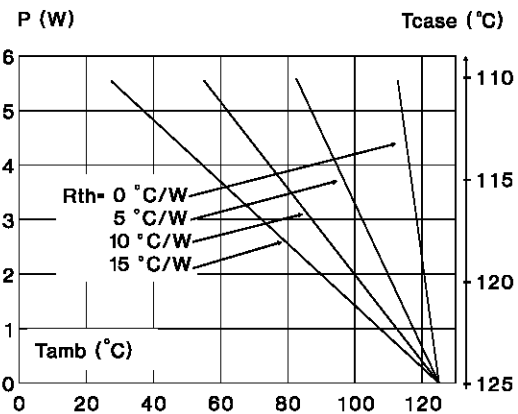


Fig.4 : RMS on-state current versus case temperature.

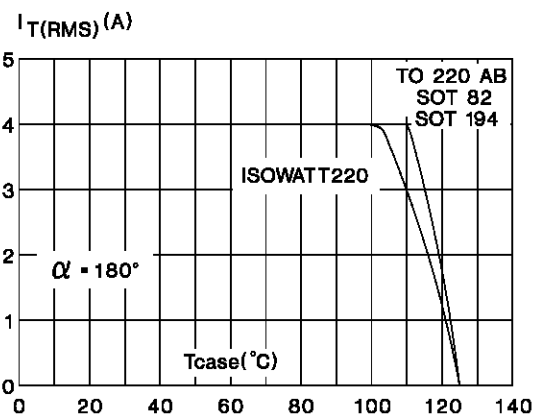


Fig.5 : Relative variation of thermal impedance versus pulse duration (SOT82 / SOT194 / TO220AB only).

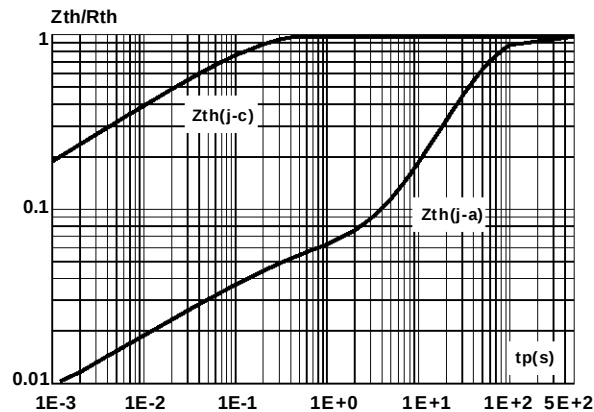


Fig.6 : Relative variation of thermal impedance versus pulse duration (ISOWATT220AB only).

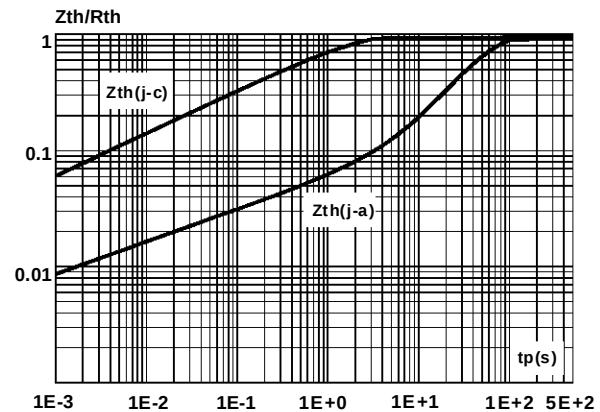


Fig.7 : Relative variation of gate trigger current and holding current versus junction temperature.

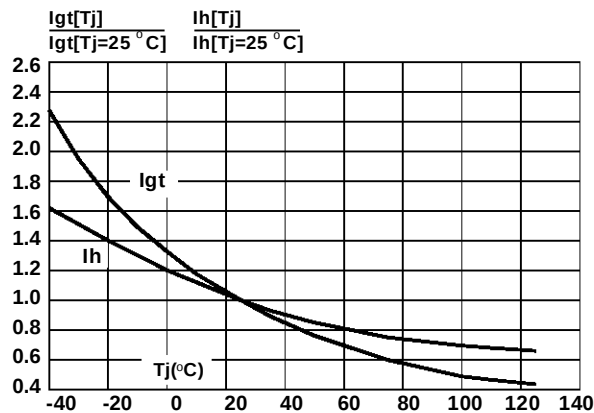


Fig.8 : Non Repetitive surge peak on-state current versus number of cycles.

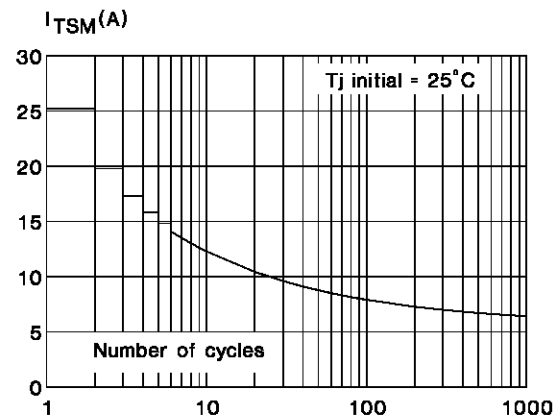


Fig.9 : Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10\text{ms}$, and corresponding value of I^2t .

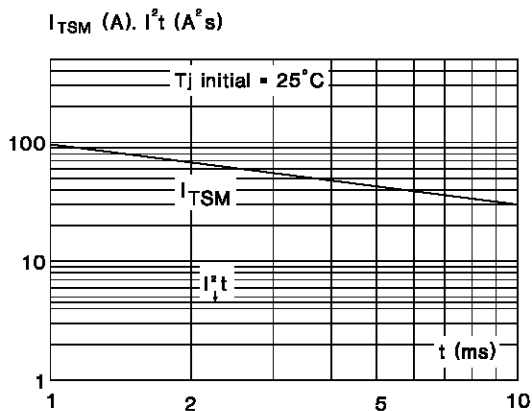
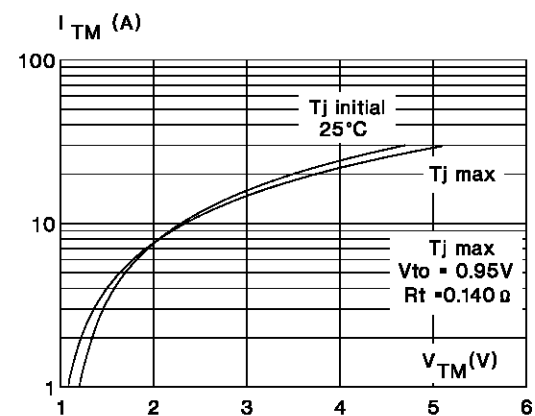
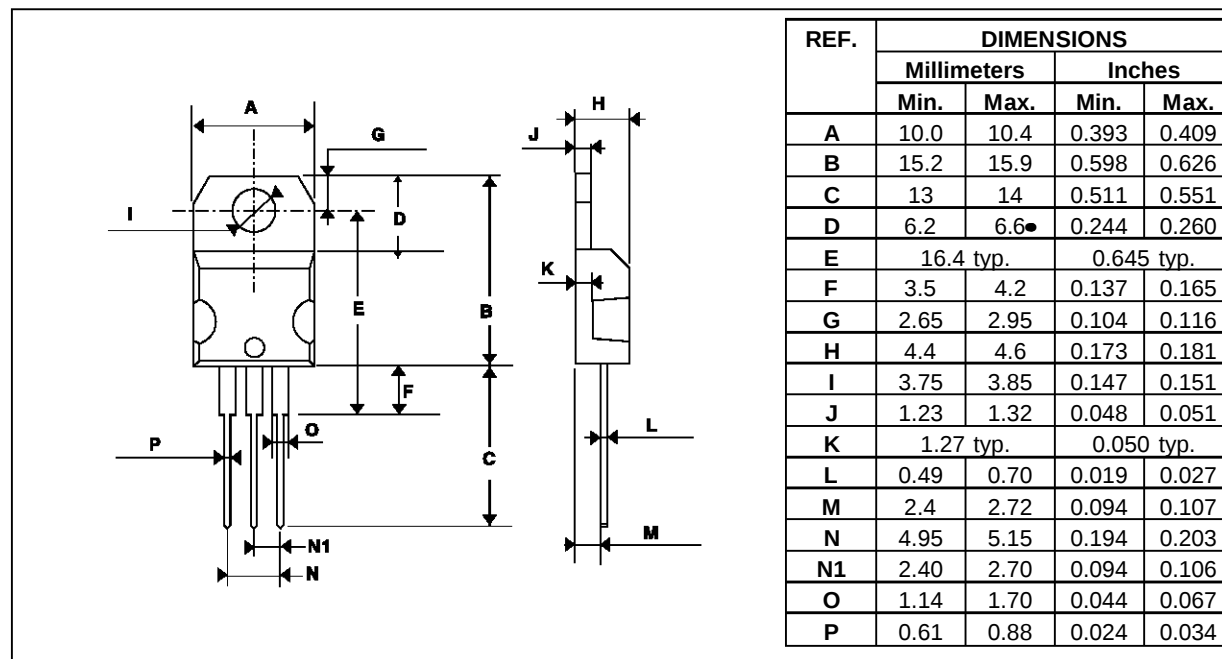


Fig.10 : On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

TO220AB Plastic



Cooling Method : C

Marking : Type number

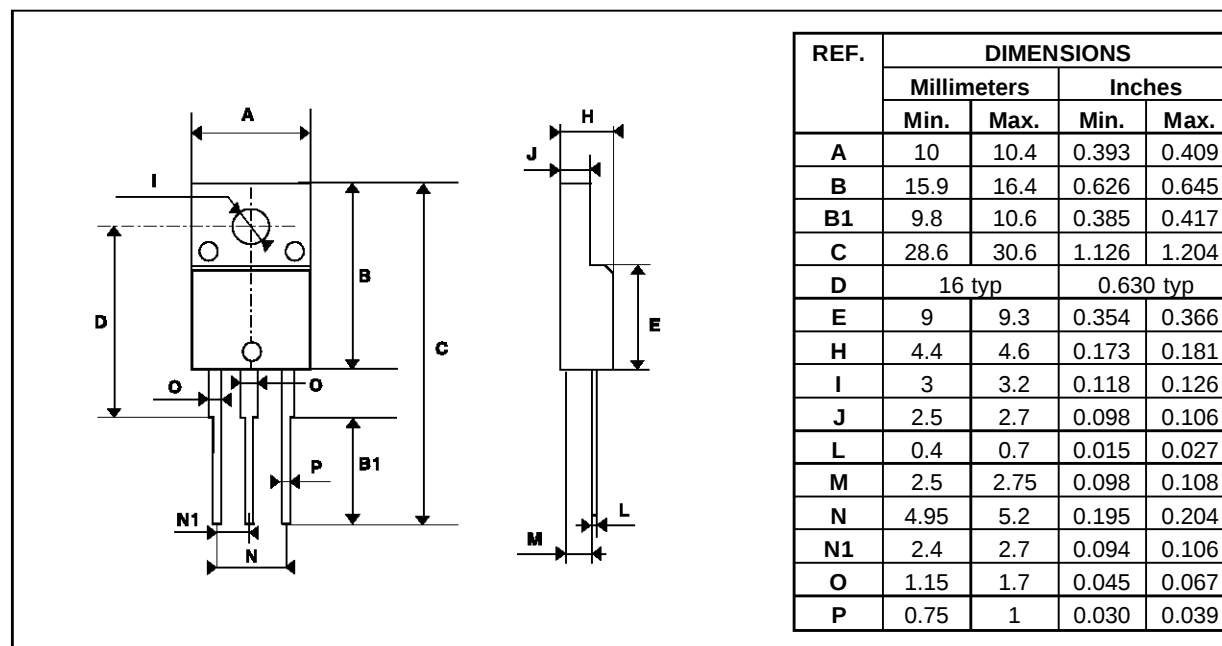
Weight : 2 g

Recommended torque value : 0.55 m.N.

Maximum torque value : 0.70 m.N.

PACKAGE MECHANICAL DATA

ISOWATT220AB Plastic



Cooling Method : C

Marking : Type number

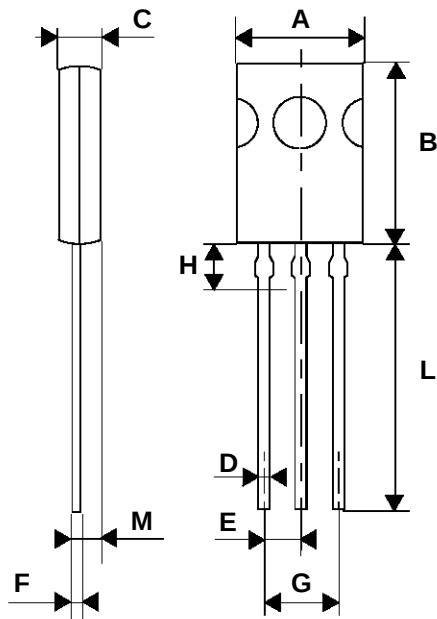
Weight : 2.1g

Recommended torque value : 0.55 m.N.

Maximum torque value : 0.70 m.N.

PACKAGE MECHANICAL DATA

SOT82 Plastic



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	7.4	7.8	0.291	0.307
B	10.5	10.8	0.413	0.425
C	2.4	2.7	0.094	0.106
D	0.7	0.9	0.027	0.035
E	2.2 typ.		0.087 typ.	
F	0.49	0.75	0.019	0.029
G	4.15	4.65	0.163	0.183
H (1)		2.54		0.100
L	15.7 typ.		0.618 typ.	
M	1.0	1.3	0.039	0.051

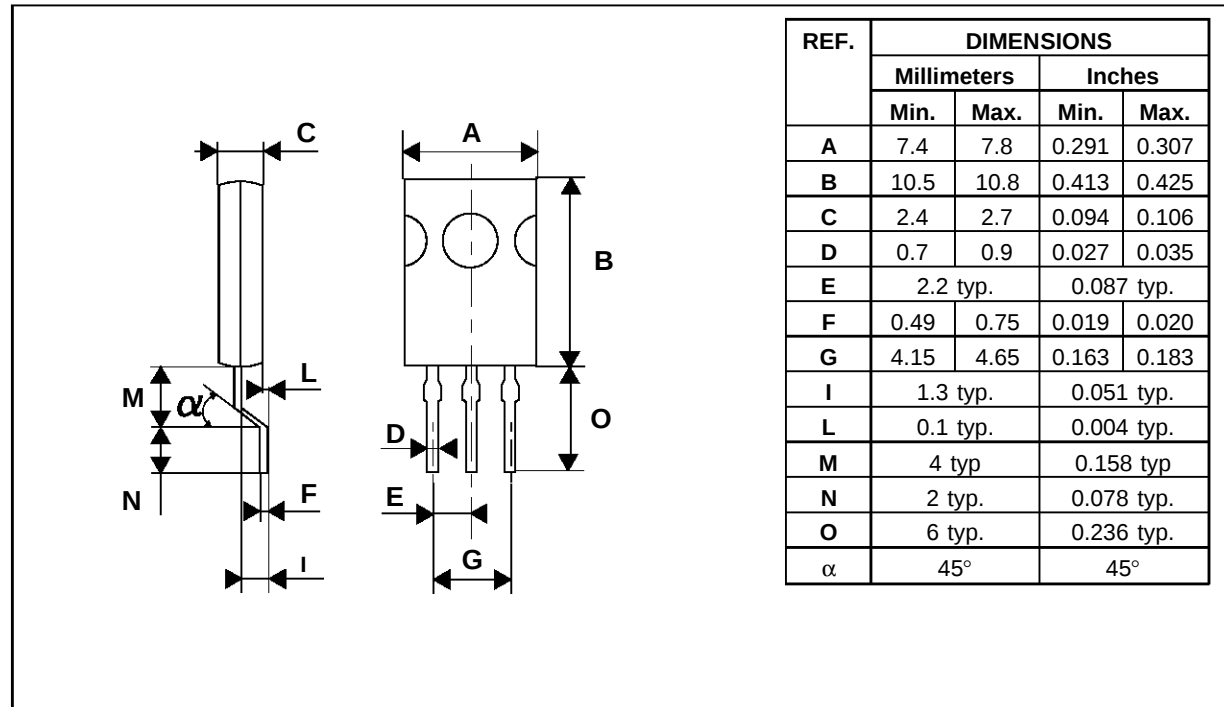
(1) Within this region the cross-section of the leads is uncontrolled

Marking : Type number

Weight : 0.72g

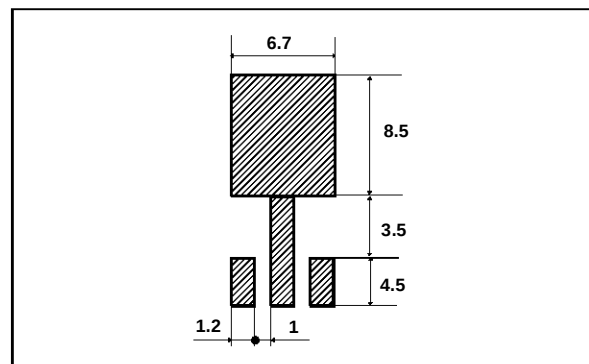
PACKAGE MECHANICAL DATA

SOT194 Plastic



Marking : Type number

Weight : 0.68g

FOOT PRINT

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